## **AN6326N**

## VTR Head Amplifier Circuit

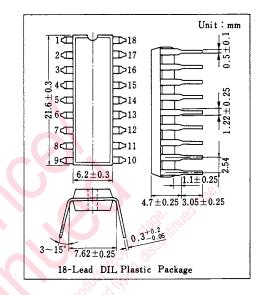
#### Outline

The AN6326N is an integrated circuit designed for VTR'S head amplifier.

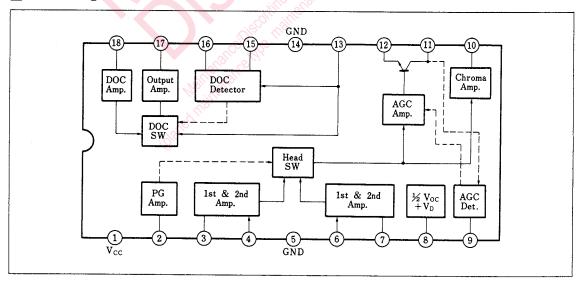
#### Features

The function consist of:
Video signal pre-amplifier circuit
Head switchover circuit
Drop-out compensation circuit
RF AGC circuit

- Low-noise head amplifier
- Supply voltage: 5V



#### Block Diagram



#### Pin

Pin No.	Pin Name	Pin No.	Pin Name		
1	$V_{cc}$	10	Chroma Output		
2	PG Input	11	FM Output		
3	Damping (1)	12	FM Equalizer		
4	FM Input (1)	13	DOC Input		
5	GND	14	GND		
6	FM Input (2)	15	DOC Pulse		
7	Damping (2)	16	DOC Detect		
8 -	Reference Voltage	17	FM Output		
9	AGC Detect	18	DOC Amp. Input		

#### Absolute Maximum Ratings $(Ta=25^{\circ})$

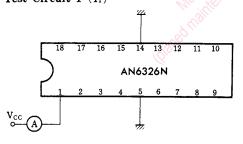
Item	Symbol	Rating	Unit
Supply voltage	V <sub>cc</sub>	6.0	V
Power dissipation	P <sub>D</sub>	160	mW
Operating ambient temperature	Topr	$-20 \sim +70$	CS
Storage temperature	T <sub>stg</sub>	$-40 \sim +150$	0°C

### ■ Electrical Characteristics ( $V_{cc} = 5 \text{ V}$ , $Ta = 25 \text{ C} \pm 2 \text{ C}$ )

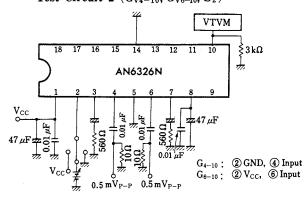
Item	Symbol	Test Circuit	Condition	min.	typ.	max.	Unit
Circuit current	Iı	1		(8)	8	20	mA
Ch. 1 gain	G <sub>V4-10</sub>	2	f = 1 MHz	52.5		62.5	dB
Ch. 2 gain	G <sub>V6-10</sub>	2	f = 1 MHz	52.5		62.5	dB
AGC output amplitude	υ <sub>O(AGC-12)</sub>	3	f = 4 MHz	170		330	$mV_{P-P}$
AGC control sensitivity	Δ υ O(AGC-12)	3	f = 4 MHz			2.5	dB
Output amplifier gain	G <sub>V13-17</sub>	4	f = 4 MHz	0.05		2.7	dB
DOC amplifier gain	G <sub>V18-17</sub>	4	f = 4 MHz	10.5		14.0	dB
DOC sensitivity ON	S <sub>13-1</sub>	4	f = 4 MHz			-19	dB
DOC sensitivity OFF	S <sub>13-2</sub>	4	f = 4 MHz	-10.8			dB
PG input sensitivity	S <sub>2</sub>	2	illu alai			3	V
Noise voltage referred to input	Vnil	5	1 MHz BPF			1	μV <sub>rms</sub>
Noise voltage referred to input	V <sub>ni2</sub>	5 🚫	1 MHz BPF			1	μV <sub>rms</sub>

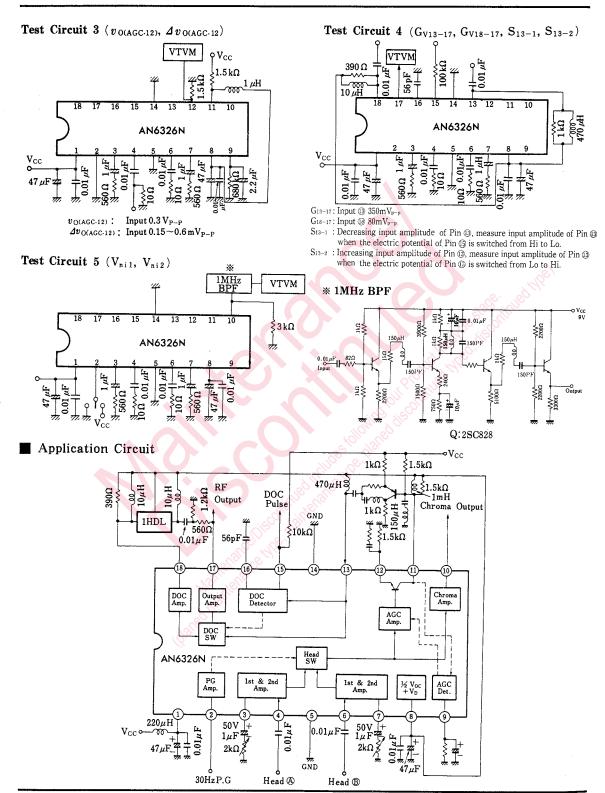
Note) Operating supply voltage range V<sub>cc(opr.)</sub> =4.5~5.5V

Test Circuit 1 (I1)



**Test Circuit 2**  $(G_{V4-10}, G_{V6-10}, S_2)$ 





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